## **UI Platform**

IK6207TQ-ER

### **Description**

IK6207TQ-ER has a C8052 devices. It is fully integrated mixed-signal system-on-a-chip MCUs. The IK6207TQ-ER utilizes CORERIVER 'TouchCore 380 microcontroller core.

The IK6207TQ-ER are cathode-grid LED display drives with output size - 4 digits x13 segments or 7 digits x 10 segments .

#### **Features**

- Operation voltage for digital part: 3.0V ~ 3.6V
- Operation voltage for output LEDs: 5.0V
- Operation Frequency : Max.48MHz
- 7-step individual dimming control for each grid
- LCD OSC: built in (with external resistor) 500kHz @ R=12.1kΩ
- Pulse segment current: 10mA @ VDD = 3.3V
- 11- channel Touch Sensing
  - Capacitive Type Touch & Digital Sensing
  - 16-bit level Resolution
- CPU
- 8 bit Turbo 8052 Architecture
- Memory
  - 16kB Flash (Including 1kB User EEPROM)
  - 512B Internal Aux RAM
- 256B Internal RAM
- 12 Bit Analog to Digital Converter
- Digital Peripherals
- Up to 18 Port I/O
- 3 general purpose 16 bit counter/timers
- UĂRT
- SPI
- I2C
- Interrupt
- Power Save Modes
- Operation Temperature : -40 ~ 85°C

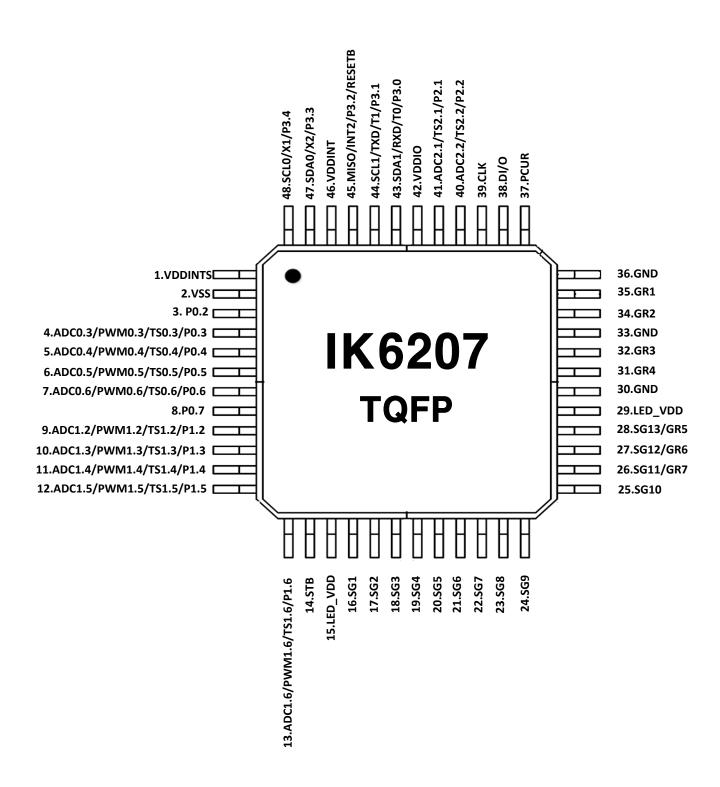
|--|

Device	Operating Temperature Range	Package
IK6207TQ-ER	$T_A = -40^{\circ} \text{ to } 85^{\circ} \text{ C}$	TQFP-48

### **Application**

• Home Appliance: Washing machine, Refregerator, Bidet, Air Conditioner





# **PIN DESCRIPTION**

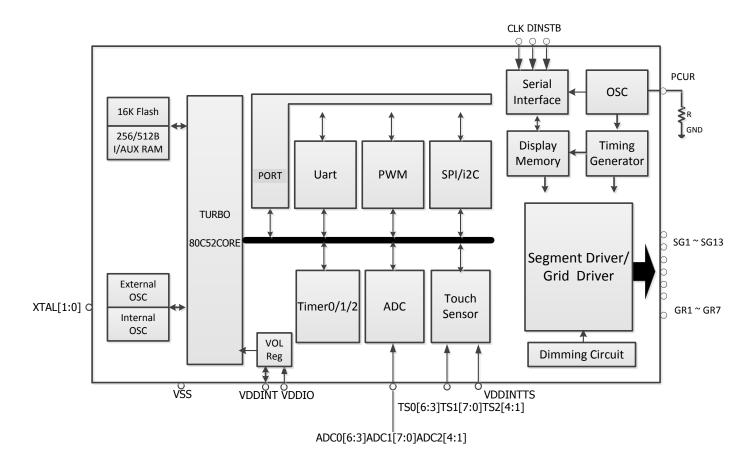
Pin Name	I/O	Description	Pin №
VDDIO	1	Digital I/O Power	42
VDDINT	0	Digital Power Input /Output ( + 1.8V )	46
VDDINITS	0	Touch Sensor Power Input / Output(+ 1.8V )	1
RESETB	I	External Reset( Active Low )	45
VSS	I	Digital Ground	2
XTAL1	I	Input to the inverting OSC	48
XTAL2	0	Output to the inverting OSC	47
I2C1_SDA/I2C2_SDA	I/O	Serial Data pin for ISP/MDS	43,47
I2C1_SCL/I2C2_SCL	I/O	Serial Data pin for ISP/MDS	44,48
TXD	0	Alternative UART Serial Port Output	44
RXD	I	Alternative UART Serial Port Output	43
P0[7:2]	I/O	An 8-bit open-Drain or push-pull I/O port. Note that the output is fully driven (push-pull) when P0 drives PWM0 output.  P0.2 open-Drain or push-pull I/O port. P0.7 open-Drain or push-pull I/O port.  P0.3 PWM0.3: PWM output 0.3 P0.4 PWM0.4: PWM output 0.4 P0.5 PWM0.5: PWM output 0.5 P0.6 PWM0.6: PWM output 0.6  P0.3 ADC0.3: A/D Converter Input 0.3 P0.4 ADC0.4: A/D Converter Input 0.4 P0.5 ADC0.5: A/D Converter Input 0.5 P0.6 ADC0.6: A/D Converter Input 0.6  P0.3 TS0.3: Touch Sensing channel 0.3 P0.4 TS0.4: Touch Sensing channel 0.4 P0.5 TS0.5: Touch Sensing channel 0.5 P0.6 TS0.6: Touch Sensing channel 0.5	3,4,5,6, 7,8
P1[6:2]	I/O	An 8-bit open-Drain or push-pull I/O port. Note that the output is fully driven (push-pull) when P1[3:2] drives PWM1[3:2] output.  P1.2 PWM1.2 : PWM output 1.2 P1.3 PWM1.3 : PWM output 1.3 P1.4 PWM1.4 : PWM output 1.4 P1.5 PWM1.5 : PWM output 1.5 P1.6 PWM1.6 : PWM output 1.6  P1.2 ADC1.2 : A/D Converter Input 1.2 P1.3 ADC1.3 : A/D Converter Input 1.3 P1.4 ADC1.4 : A/D Converter Input 1.4 P1.5 ADC1.5 : A/D Converter Input 1.5	9,10,11, 12,13



GR1 to GR4	0	Grid Output Pins	31 - 35
SG11/GR6 to SG13/GR5	0	Segment / Grid Output Pins	26 - 28
SG1 to SG10	0	Segment output Pins ( P-Channel, Open Drain )	16-25
STB	I	Serial Interface Strobe Pin The data input after the STB has fallen is processed as a command. When this pin is HIGH,CLK is ignores.	14
CLK	I	Clock Input Pin This pin reads serial data at the rising edge and output data at the falling edge.	39
DI/O	I/O	Data Input /Output Pin This pin inputs serial data at the rising edge of the shift clock ( starting from the bit ) Data Output Pin – N channel Open Drain This pin outputs serial data at the falling edge of the shift clock	38
PUCR	I	A resistor is connected to this pin to determine the output currents and oscillation frequency.	37
GND	-	Ground Pin	30,36
LED_VDD	-	LED Power Supply	15,29
P3[4:0]		<ul> <li>P3.0 I2C1_SDA: I2C Serial Data</li> <li>P3.1 I2C1_SCL: I2C Serial Clock</li> <li>P3.3 I2C0_SDA: I2C0 Serial Data</li> <li>P3.4 I2C0_SCL: I2C0 Serial Clock</li> <li>P3.0 SSB: SPI Slave Select Bar</li> <li>P3.1 SCLK: SPI Serial Clock</li> <li>P3.2 MISO: SPI Master Input Slave Output</li> <li>P3.3 MOSI: SPI Master Output Slave Input</li> <li>P3.1 TXD: UART Serial Port Input</li> <li>P3.1 TXD: UART Serial Port Output</li> <li>P3.1 INT0: External Interrupt 0 (Positive/Negative Edge)</li> <li>P3.1 INT1: External Interrupt 1 (Positive/Negative Edge)</li> <li>P3.2 INT2: External Interrupt 1 (Positive/Negative Edge)</li> <li>P3.3 INT3: External Interrupt 3 (Positive/Negative Edge)</li> <li>P3.4 INT4: External Interrupt 4 (Positive/Negative Edge)</li> </ul>	43,44,45, 47,48
		P2.1 TS2.1 : Touch Sensing channel 2.1 P2.2 TS2.2 : Touch Sensing channel 2.2 A 5-bit open-drain or push-pull I/O port. Optional Pull-up Control Enable (Only P3[1:0])	
P2[2:1]	I/O	<ul> <li>P2.1 ADC2.1 : A/D Converter Input 2.1</li> <li>P2.2 ADC2.2 : A/D Converter Input 2.2</li> </ul>	40,41
		<ul> <li>P1.6 ADC1.6: A/D Converter Input 1.6</li> <li>P1.2 TS1.2: Touch Sensing channel 1.2</li> <li>P1.3 TS1.3: Touch Sensing channel 1.3</li> <li>P1.4 TS1.4: Touch Sensing channel 1.4</li> <li>P1.5 TS1.5: Touch Sensing channel 1.5</li> <li>P1.6 TS1.6: Touch Sensing channel 1.6</li> <li>An 8-bit open-Drain or push-pull I/O port.</li> </ul>	
		D4.C. ADC4.C. A/D Conventor Innect 4.C.	



#### **BLOCK DIAGRAM**

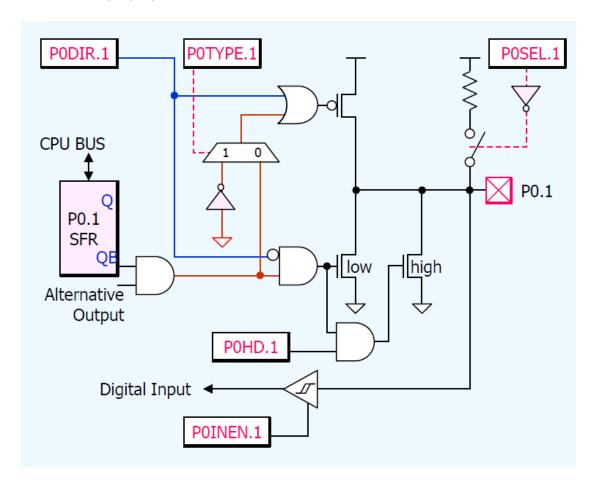




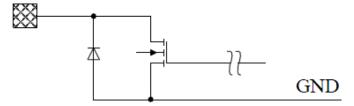
## **INPUT / OUTPUT CONFIGURATIONS**

The schematic diagrams of the input and output circuits of the logic section are shown below.

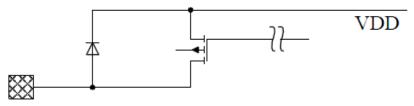
♦ I/O Port : P0,P1,P2,P3



♦ Output Pins : GR1 to GR4

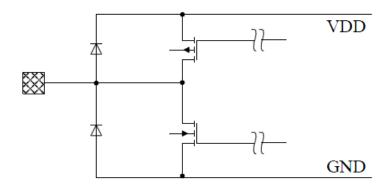


♦ Output Pins : SG2 to SG10





# ♦ Output Pins : SG12/GR5 to SG13/GR6





#### **FUNCTIONAL DESCRIPTION**

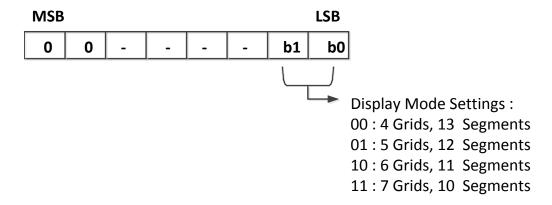
#### **COMMANDS**

A command is the first byte (b0 to b7) inputted to IK6207TQ-ER via DIN, DI/O Pin after STB Pin has changed From "HIGH" to "LOW" state. If for some reason the STB Pin is set "HIGH" while data or commands Are being transmitted, the serial communication is initialized, and the data/ commands being transmitted are considered invalid.

#### **COMMAND 1: DISPLAY MODE SETTING COMMANDS**

IK6207TQ-ER provides 4 display mode setting as shown in the diagram below: As stated earlier a command is the first one byte(b0 to b7) transmitted to IK6207TQ-ER via the DIN, DI/O Pin when STB is "LOW". However, for these commands, Bit 3 & Bit 8 (b2 to b7) are given a value of "0".

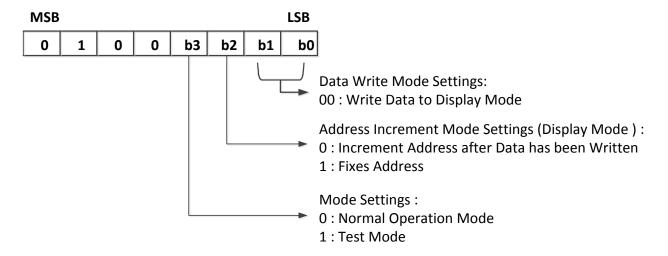
The Display Mode Setting Commands determine the number of segments and grids be used (14 to 9 segments, 4 to 7 grids). A display command "ON" must be executed in order to resume display. If the same mode setting is selected, no command execution is take place, therefore, nothing happens. When Power is turned "ON", the mode 11 is selected.





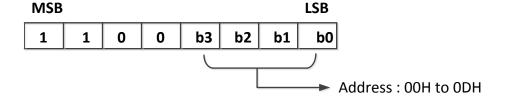
#### **COMMAND 2: DATA SETTING COMMANDS**

The Data Setting Commands executes the Data Write Mode for IK6207TQ-ER. The Data Setting Command, the bits5 and 6 (b4, b5) are given the value of "0"., bit7 (b6) is given the value of "1" while bit8 (b7) is given the value of "0". Please refer to the diagram below. When power is turned ON, bit 4 to bit 1 (b3 to b0) are given the value of "0".



#### **COMMAND 3: ADDRESS SETTING COMMANDS**

Address Setting Commands are used to set the address of the display memory. The address is considered valid if it has a value of "00H" to 0DH". If the address is set to 0EH or higher, the data is ignored until a valid address is set. When power is turned ON, the address is set at "00H". Please refer to the diagram below.





#### **DISPLAY MODE AND RAM ADDRESS**

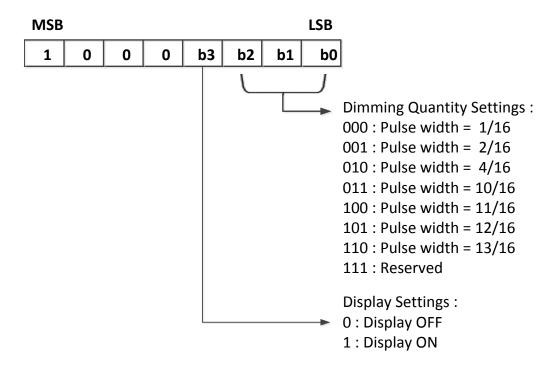
Data transmitted from an external device to IK6207TQ-ER via the serial interface are stored in the Display RAM and are assigned addresses. The RAM Addresses of IK6207TQ-ER are given below in 8 bit unit.

	SG1 SG4	SG5 SG8	SG9 SG12
GR1	$00H_{L}$	$00H_{U}$	$01H_{L}$
GR2	$02H_L$	$02H_{U}$	$03H_L$
GR3	$04H_L$	$04H_{U}$	$05H_L$
GR4	$06H_L$	$06H_{U}$	$07H_{L}$
GR5	$08H_L$	$08H_{U}$	$09H_L$
GR6	$0AH_L$	$0AH_{U}$	$0\mathrm{BH_L}$
GR7	$0CH_L$	$0CH_U$	$0\mathrm{DH_L}$

b0		b3	b4	b7
	$xxH_{L}$			$xxH_{\rm U}$
	Lower 4 bits	5		Higher 4 bits

#### **COMMAND 4: DISPLAY CONTROL COMMANDS**

The Display Control Commands are used to turn ON or OFF a display. It also used to set the pulse width. Please refer to the diagram below. When the power is turned ON, a 1/16 pulse width is selected and the displayed is turned OFF.





## **SCANNING AND DISPLAY TIMING**

	ToeseLav=512us					
SG Output	DIG1	DIG2	DIG3	 DIGn	Key Scan	DIG1
G1						
G2						
G3						
Gn						

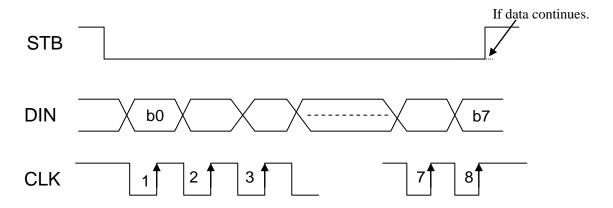
1 Frame = Tdisplay x (n+1)



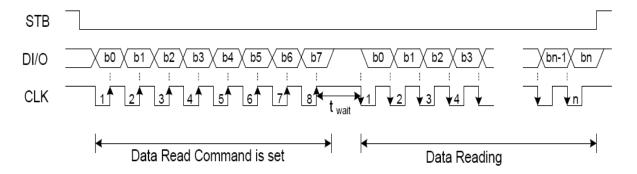
#### **SERIAL COMMUNICATION FORMAT**

The following diagram shows the serial communication format.

# **RECEPTION (DATA/COMMAND WRITE)**



# TRANSMISSION( DATA READ )

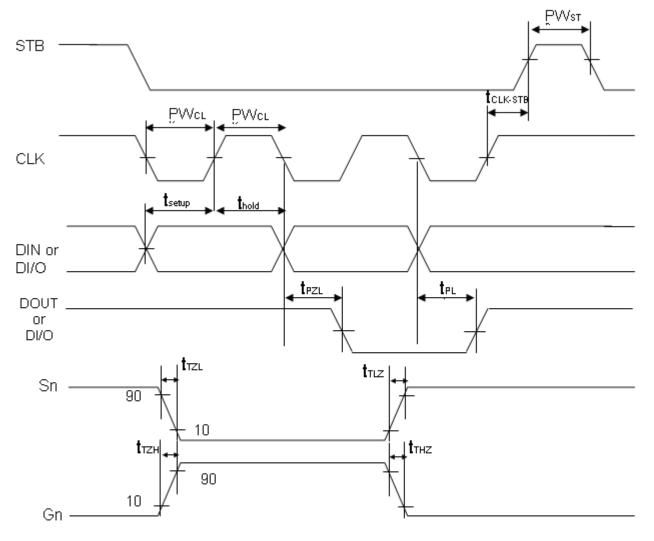


Where:  $t_{wait}$  (waiting time)  $\ge 1 \mu s$ 



#### SWITCHING CHARACTERISTIC WAVEFORM

Switching Characteristics Waveform is given below.



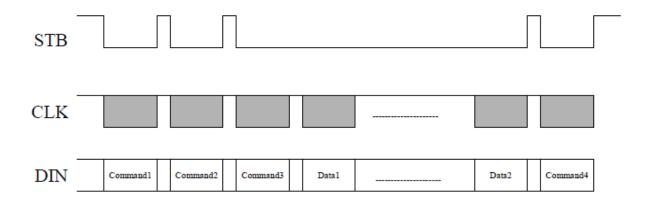
PW <sub>CLK</sub> (Clock Pulse Width) ≥400ns t setup (Data Setup Time) ≥ 100ns t <sub>CLK-STB</sub> (Clock - Strobe Time) ≥ 1 $\mu$ s t <sub>TZH</sub> (Rise Time) ≤ 1 $\mu$ s t <sub>TZL</sub> <1 $\mu$ s

PW<sub>STB</sub> (Strobe Pulse Width)  $\geq 1 \mu s$  thold (Data Hold Time)  $\geq 100 ns$  t <sub>THZ</sub> (Fall Time)  $\leq 10 \mu s$  fosc = Oscillation Frequency t <sub>TIZ</sub> <  $10 \mu s$ 



#### **APPLICATIONS**

Display memory is updated by incrementing addresses. Please refer to the following diagram.



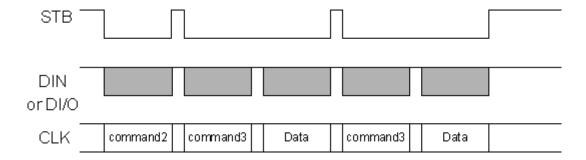
Where: Command 1: Display Mode Setting

Command 2: Data Setting Command Command 3: Address Setting Command

Data 1 to n: Transfer Display Data (14 Bytes max.)

Command 4: Display Control Command

The following diagram shows the waveforms when updating specific addresses.

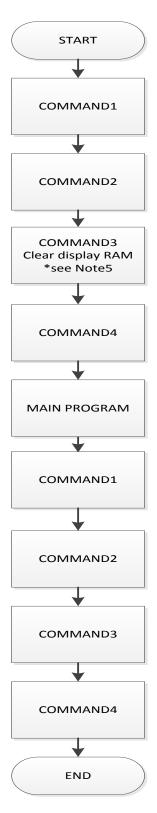


Where: Command 2 -- Data Setting Command Command 3 -- Address Setting Command

Data -- Display Data



#### RECOMMENDED SOFTWARE PROGRAMMING FLOWCHART

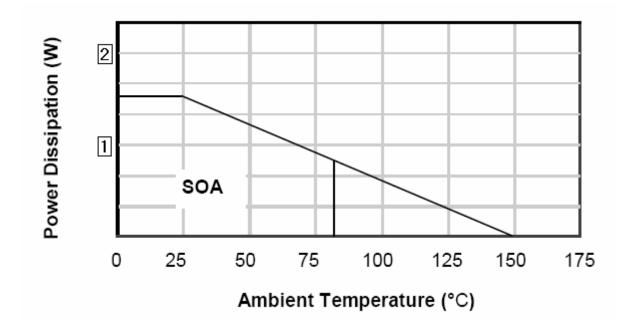


Note: 1. Command 1: Display Mode Setting

- 2. Command 2: Data Setting Commands
  3. Command 3: Address Setting Commands
- 4. Command 4: Display control Commands
- 5. When IC power is applied for the first time, the contents of the Display RAM are not defined: thus, it is strongly suggested that the contents of the Display RAM must be cleared during the initial setting.



# **POWER DISSIPATION CURVE**





### MCU ABSOLUTE MAXIMUM RATINGS

(Unless otherwise stated, Ta=25°C, GND=0V)

Parameter	Symbol	Rating	Units
Voltage on any pin relative to Ground	-	-0.5V to (V <sub>DDIO</sub> + 0.5V)	V
Voltage in VDDIO relative to Ground	-	-0.5V to 3.6V	V
Output Voltage		-0.5V to (V <sub>DDIO</sub> + 0.5V)	V
Output Current High	One I/O pin active	-25mA	mA
Output Current High	igh All I/O pin active -100mA		IIIA
Output Current Low	One I/O pin active	in active +30mA	
Output Current Low	Output Current Low  All I/O active		mA
Storage Temperature	-	-65°C to + 150°C	°C
Soldering Temperature	-	260 $^{\circ}$ C, 10 seconds within 5 $^{\circ}$ C of actual peak temperature	°C

<sup>\*</sup>Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability



### LED ABSOLUTE MAXIMUM RATINGS

(Unless otherwise stated, Ta=25°C, GND=0V)

Parameter	Symbol	Rating	Units
Supply Voltage	V <sub>DD</sub>	-0.5 to +6.0	V
Logic Input Voltage	V <sub>I</sub>	-0.5 to V <sub>DD</sub> +0.5	V
Deixor Output Current/Din	${ m I}_{ m OHGR}$	-24	mA
Driver Output Current/Pin	I <sub>OLSG</sub>	300	mA
Maximum Driver Output Current/Total	I <sub>TOTAL</sub>	300	mA

<sup>\*</sup>Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability



## LED RECOMMENDED OPERATING RANGE

(Unless otherwise stated, Ta= -40 to +85°C, GND=0V)

Parameter	Symbol	Min	Тур	Max	Unit
Logic Supply Voltage	$V_{DD}$	3.0	3.3	5.5	V
Dynamic Current (see Note)	$I_{DDdyn}$			1	mA
High-Level Input Voltage	V <sub>IH</sub>	0.7V <sub>DD</sub>		$V_{DD}$	V
Low-Level Input Voltage	V <sub>IL</sub>	0		0.3 V <sub>DD</sub>	V

Note: Test Condition: Set Display Control Commands = 80H (Display Turn OFF State)



## MCU DC ELECTRICAL CHARACTERISTICS

TA = -40  $^{\circ}$ C to +125  $^{\circ}$ C, V<sub>DDIO</sub> = +2.7V to +3.6V unless otherwise specified.

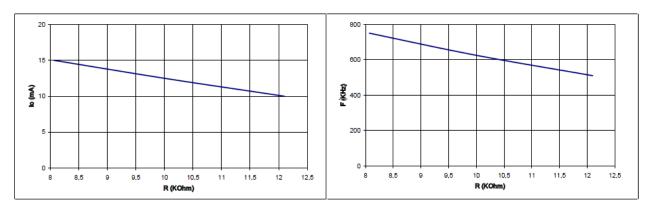
Parameter	Symbol	Pin	Conditions		Value		Unit
				Min.	Тур.	Max.	
Input Low Voltage	V <sub>IL</sub>	P0,P1,P2 ,P3	$V_{DDIO} = +2.7V \text{ to } +3.6V$	-0.5	-	0.2V <sub>DDIO</sub> +0.1	V
Input High Voltage	$V_{\mathrm{IH}}$	P0,P1,P2 ,P3	$V_{DDIO} = +2.7V \text{ to } +3.6V$	0.2V <sub>DDIO</sub> +1.0	-	V <sub>DDIO</sub> +0.5	V
Output Low Voltage	V <sub>OL</sub>	P0,P1,P2 ,P3	$V_{DDIO} = +3.0V \text{ to } +3.6V$ $(I_{OL} = 4.35\text{mA})$ $V_{DDIO} = +2.7V \text{ to } +3.0V$ $(I_{OL} = 3.35\text{mA})$	-	-	0.3V <sub>DDIO</sub>	V
		P0,P1,P2 ,P3[1:0] (High Drive)	$V_{DDIO} = +3.0V \text{ to } +3.6V$ $(I_{OL} = 34.79\text{mA})$ $V_{DDIO} = +2.7V \text{ to } +3.0V$ $(I_{OL} = 28.41\text{mA})$	-	-	0.3V <sub>DDIO</sub>	V
Output High Voltage	V <sub>OH</sub>	P0,P1,P2 ,P3	$V_{\rm DDIO} = +3.0 \text{V to } +3.6 \text{V}$ $(I_{\rm OH} = -8.04 \text{mA})$ $V_{\rm DDIO} = +2.7 \text{V to } +3.0 \text{V}$ $(I_{\rm OH} = -6.62 \text{mA})$	0.7V <sub>DDIO</sub>	-	-	V
	V <sub>OHP</sub>	P0,P1,P2 ,P3 (Pull-up Resistor Only)	$V_{DDIO} = +3.0V \text{ to } +3.6V$ $(I_{OHP} = -30.30 \text{uA})$ $V_{DDIO} = +2.7V \text{ to } +3.0V$ $(I_{OHP} = -24.26 \text{uA})$	0.7V <sub>DDIO</sub>	-	-	V
Logical 1 to 0 Transition Current	I <sub>TL</sub>	P0,P1,P2 ,P3	$V_{DDIO} = 3.0V \pm 10\%$ ( $V_{IN} = +2.0V$ )		-	-650	uA
Input Leakage Current	$I_{IL}$	P0,P1,P2 ,P3	$V_{IN} = V_{IH} \text{ or } V_{IL}$		-	±1	uA
Pin Capacitance	C <sub>IO</sub>	All	$V_{DDIO} = +3.0V$		10	-	pF



## LED ELECTRICAL CHARACTERISTICS

(Unless otherwise stated, VDD=3.3~5.5V, GND=0V, Ta=-40 ~ 85°C)

Parameter	Symbol	Conditions		Value		Unit
			Min.	Тур.	Max.	
High-Level Output Current	${ m I}_{ m OHSG1}$	$(V_{DD} = 3.3 \sim 5.5V) V_{LED} = 2.3V$ R = 12.1KOhm SG1  to  SG11 SG12/GR7  to  SG14/GR5	8	10	12	mA
	I <sub>OHSG2</sub>	$(V_{DD} = 5V) V_{LED} = 2.3V$ R = 8.07KOhm SG1  to  SG11 SG12/GR7  to  SG14/GR5	12	15	18	
Digital Input Current	$I_{DG}$	-	-0.2	-	+0.2	uA
Low-Level Digital Output Current	$I_{OLDG}$	V <sub>O</sub> = 0.4V	4	-	-	mA
Segment High- Level Output Current Tolerance	I <sub>TOLSG</sub>	$V_O = V_{DD} = 2.3V$ R = 12.1KOhm SG1 TO SG11 SG12/GR7	-	-	±5	%
High-Level Input Voltage	$V_{\mathrm{IH}}$	-	0.7V <sub>DD</sub>	-	0.3V <sub>DD</sub>	V
Low-Level Input Voltage	V <sub>IL</sub>	-	-	-	0.3V <sub>DD</sub>	V
Oscillation	f <sub>OSC1</sub>	(V <sub>DD</sub> =3.3 ~5.5V) R = 12.1kOhm	400	500	600	kHz
Frequency	f <sub>OSC2</sub>	$(V_{DD} = 5V)$ R = 8.07KOhm	500	750	900	NI IZ



High-Level Output Current

Oscillation Frequency

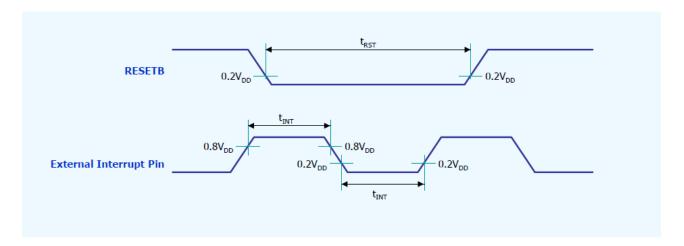
Remark : graphs are only Vdd = 5V



# MCU AC ELECTRICAL CHARACTERISTICS

TA = -40 °C to +125 °C,  $V_{DDIO}$  = +2.7V to +3.6V unless otherwise specified.

Parameter	Symbol	Pin	Conditions	Value			Unit
				Min.	Тур.	Max.	
RESETB Input Width	$t_{RST}$	RESETB	$V_{DDIO} = +3.0V \text{ to } \pm 10\%$	24	-	1	F <sub>SYS</sub>
External Interrupt Input Width	$t_{INT}$	External Interrupt	$V_{DDIO} = +3.0V \text{ to } \pm 10\%$	4	•	1	F <sub>SYS</sub>

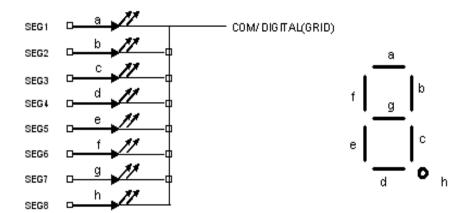




# **APPLICATION CIRCUIT**



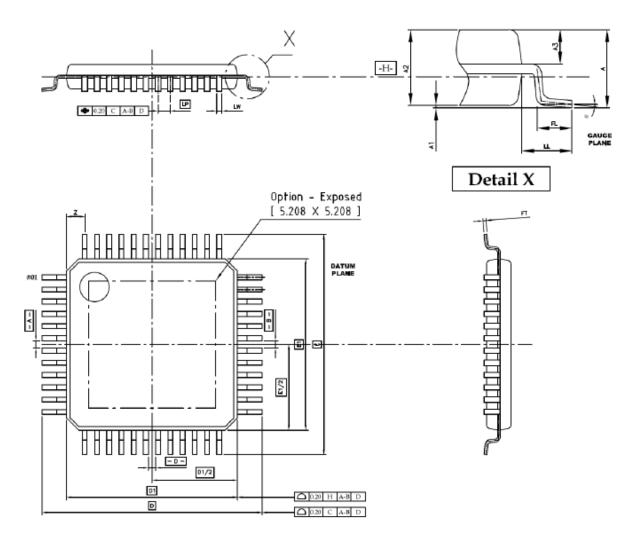
## **COMMON CATHODE TYPE LED PANEL**





## **PAKAGE DIMENSION**

### **TQFP-48**



## **DIMENSIONS**

Unit	D1	E1	D/E	FT	LP	LW	A	A1	A2	A3	LL	FL	Ө	Z
			[TL]				max							
mm	7.10	7.10	9.20	0.127	0.50	0.25	1.20	0.15	1.05	(0.44)	1.00	0.75	8	0.75
	6.90	6.90	8.80	BSC		0.15		0.05	0.95			0.45	0	

### **NOTES**

- 1. All Dimensions are in Millimeters
- 2. Dimensions Do Not include Burrs, Mole Flash, and Tie-bar Extrusions.
- 3. JEDEC References: MS-026

